



Product Change Notification

Change Notification #: 117273 - 00
Change Title: Select Intel® SSD DC P4618 Series Products, PCN 117273-00, Product Material, DRAM Updates
Date of Publication: November 26, 2019

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 25, 2020
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Description of Change to the Customer:

The Intel® SSD P4618 Series SKUs listed in the Products Affected table below will undergo the following DRAM updates:

1. Add alternate Nanya 4Gbx4 DRAM since the current 4Gbx4 Micron DRAM will be EOL Q3'2019.
2. Add alternate Hynix 16Gbx8 DRAM since the current 16xGbx8 Micron DRAM will be EOL Q2'2020.

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P4618 Series (6.4TB, 1/2 Height PCIe 3.1 x8, 3D2, TLC) Generic Single Pack	SSDPECKE064T801	999CNK

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
November 26, 2019	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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